

MOSFETs Silicon N-Channel MOS ( $\pi$ -MOSIX)

# TK750A60F

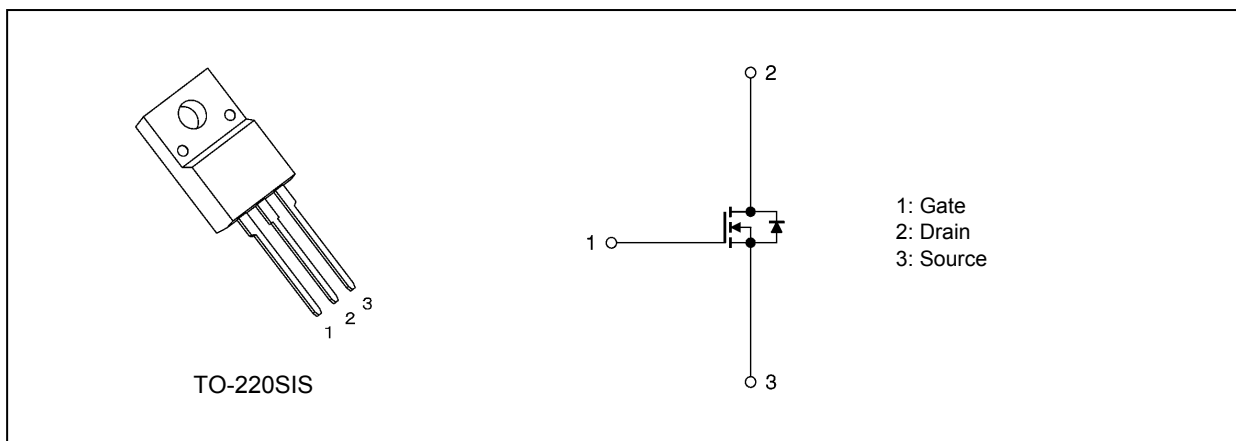
## 1. Applications

- Switching Power Supplies

## 2. Features

- (1) Easy to control Gate switching
- (2) Low drain-source on-resistance:  $R_{DS(ON)} = 0.62 \Omega$  (typ.)
- (3) Enhancement mode:  $V_{th} = 2$  to  $4$  V ( $V_{DS} = 10$  V,  $I_D = 1$  mA)

## 3. Packaging and Internal Circuit



## 4. Absolute Maximum Ratings (Note) ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	600	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	V
Drain current (DC)	$I_D$ (Note 1)	10	A
Drain current (pulsed)	$I_{DP}$ (Note 1)	40	A
Power dissipation ( $T_c = 25$ °C)	$P_D$	40	W
Single-pulse avalanche energy	$E_{AS}$ (Note 2)	201	mJ
Single-pulse avalanche current	$I_{AS}$	10	A
Reverse drain current (DC)	$I_{DR}$ (Note 1)	10	A
Reverse drain current (pulsed)	$I_{DRP}$ (Note 1)	40	A
Channel temperature	$T_{ch}$	150	°C
Storage temperature	$T_{stg}$	-55 to 150	°C
Isolation voltage (RMS)	$V_{ISO(RMS)}$ ( $t = 1.0$ s)	2000	V
Mounting torque	TOR	0.6	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production

2017-12

## 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	3.12	°C/W
Channel-to-ambient thermal resistance	$R_{th(ch-a)}$	62.5	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2:  $V_{DD} = 90\text{ V}$ ,  $T_{ch} = 25\text{ °C}$  (initial),  $L = 3.53\text{ mH}$ ,  $I_{AS} = 10\text{ A}$

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

### 6. Electrical Characteristics

#### 6.1. Static Characteristics ( $T_a = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 1$	$\mu\text{A}$
Drain cut-off current	$I_{DSS}$	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	600	—	—	V
Gate threshold voltage	$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2	—	4	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 5\text{ A}$	—	0.62	0.75	$\Omega$

#### 6.2. Dynamic Characteristics ( $T_a = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = 300\text{ V}, V_{GS} = 0\text{ V}, f = 100\text{ kHz}$	—	1130	—	$\mu\text{F}$
Reverse transfer capacitance	$C_{rss}$		—	8.5	—	
Output capacitance	$C_{oss}$		—	40	—	
Gate resistance	$r_g$	$V_{DS} = \text{OPEN}, f = 1\text{ MHz}$	—	5.4	—	$\Omega$
Switching time (rise time)	$t_r$	See Figure 6.2.1	—	22	—	ns
Switching time (turn-on time)	$t_{on}$		—	45	—	
Switching time (fall time)	$t_f$		—	20	—	
Switching time (turn-off time)	$t_{off}$		—	80	—	
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} \leq V_{(BR)DSS}, I_D \leq 5\text{ A}$	15	—	—	V/ns

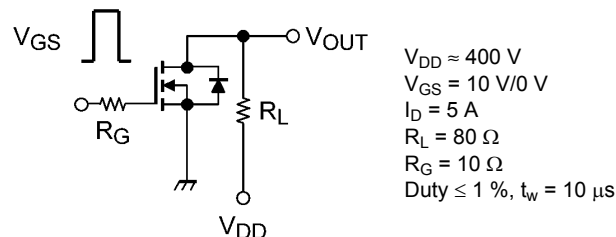


Fig. 6.2.1 Switching Time Test Circuit

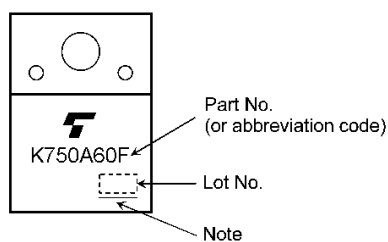
#### 6.3. Gate Charge Characteristics ( $T_a = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	—	30	—	nC
Gate-source charge 1	$Q_{gs1}$		—	7	—	
Gate-drain charge	$Q_{gd}$		—	13	—	

#### 6.4. Source-Drain Characteristics ( $T_a = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage	$V_{DSF}$	$I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$V_{DD} \approx 400\text{ V}, I_{DR} = 10\text{ A}, V_{GS} = 0\text{ V}, -dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	600	—	ns
Reverse recovery charge	$Q_{rr}$		—	3.8	—	
Peak reverse recovery current	$I_{rr}$		—	12.5	—	
Diode dv/dt ruggedness	dv/dt		$V_{DD} \leq 400\text{ V}, I_{DR} \leq 10\text{ A}, V_{GS} = 0\text{ V}$	5	—	

## 7. Marking (Note)



**Fig. 7.1 Marking**

Note: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

## 8. Characteristics Curves (Note)

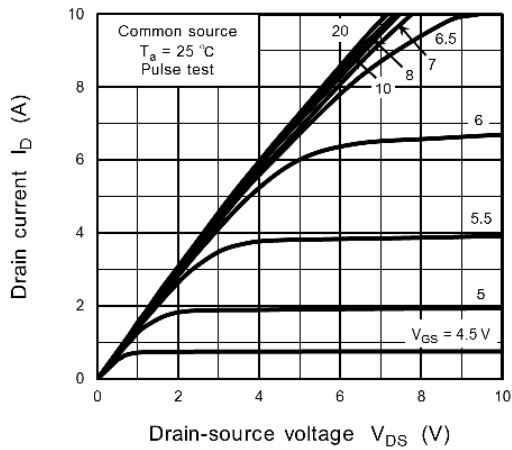


Fig. 8.1  $I_D - V_{DS}$

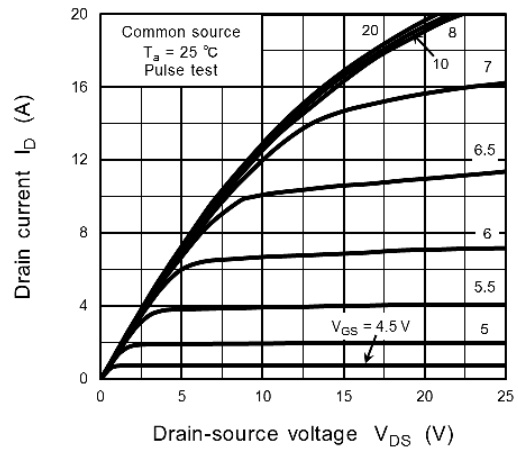


Fig. 8.2  $I_D - V_{DS}$

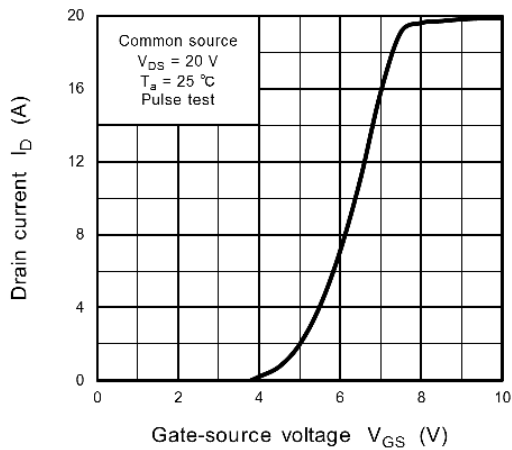


Fig. 8.3  $I_D - V_{GS}$

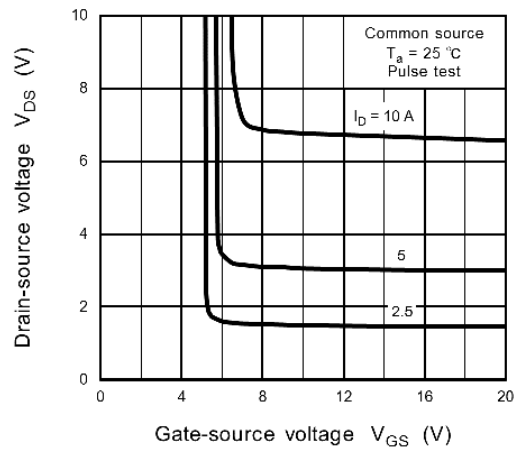


Fig. 8.4  $V_{DS} - V_{GS}$

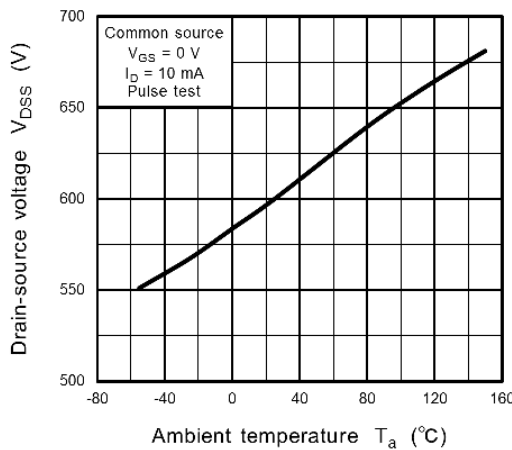


Fig. 8.5  $V_{DSS} - T_a$

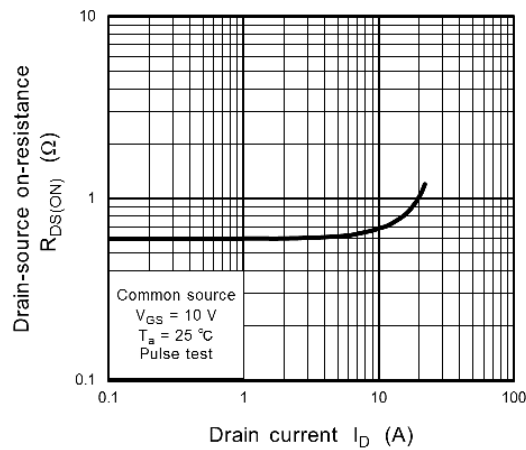


Fig. 8.6  $R_{DS(ON)} - I_D$

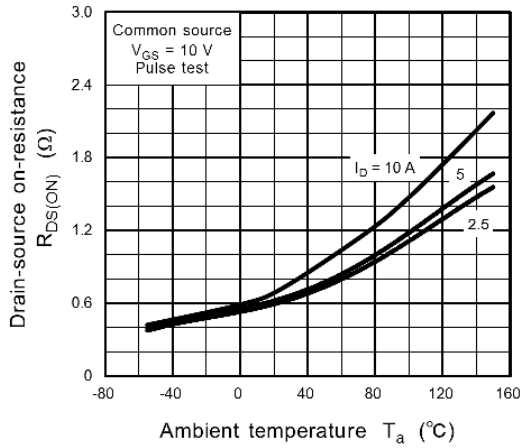


Fig. 8.7  $R_{DS(ON)} - T_a$

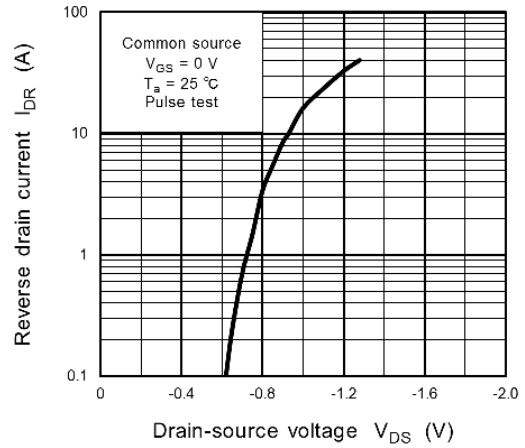


Fig. 8.8  $I_{DR} - V_{DS}$

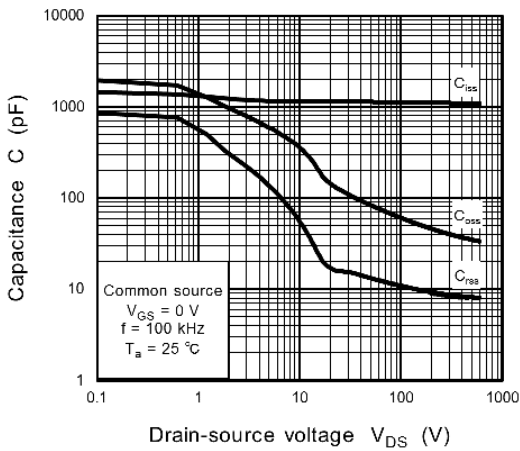


Fig. 8.9  $C - V_{DS}$

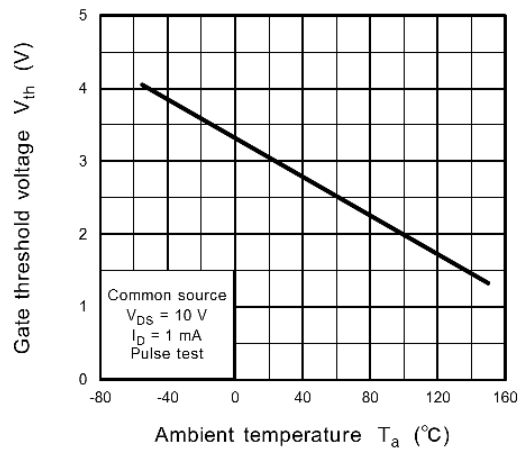


Fig. 8.10  $V_{th} - T_a$

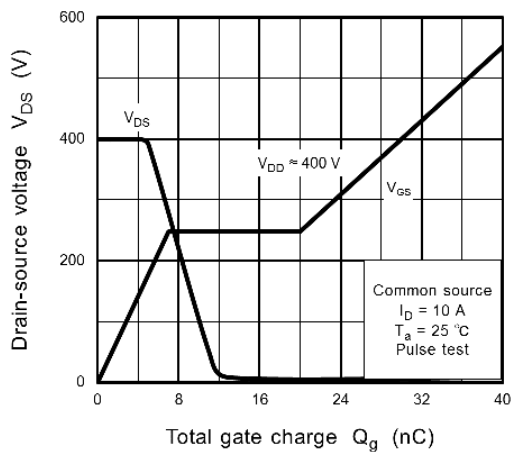


Fig. 8.11 Dynamic Input/Output Characteristics

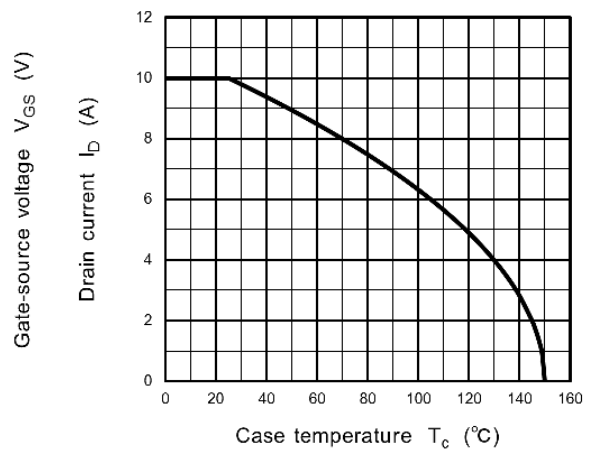
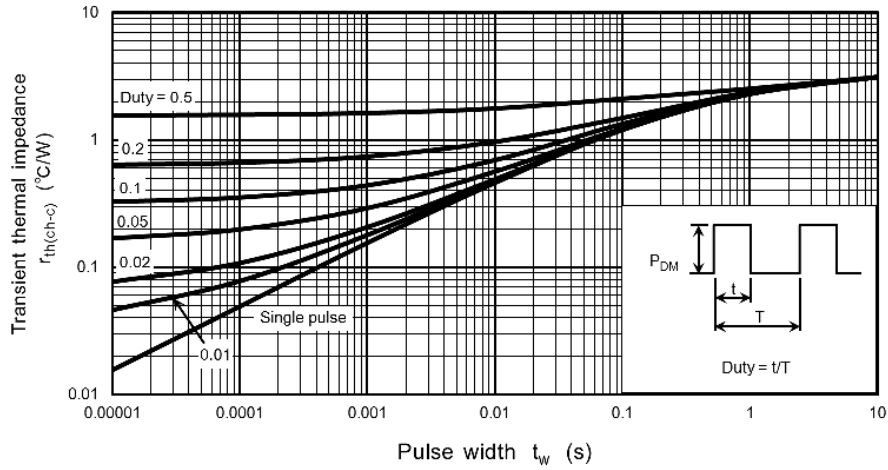
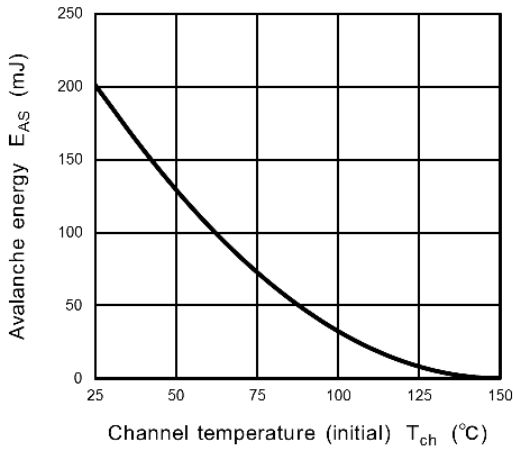


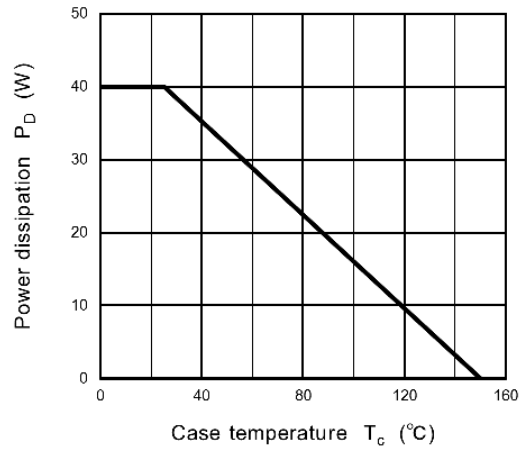
Fig. 8.12  $I_D - T_c$   
(Guaranteed Maximum)



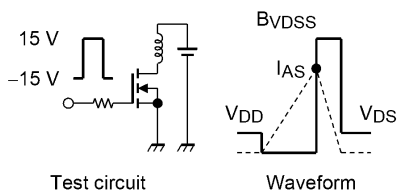
**Fig. 8.13  $r_{th} - t_w$**   
(Guaranteed Maximum)



**Fig. 8.14  $E_{AS} - T_{ch}$**   
(Guaranteed Maximum)



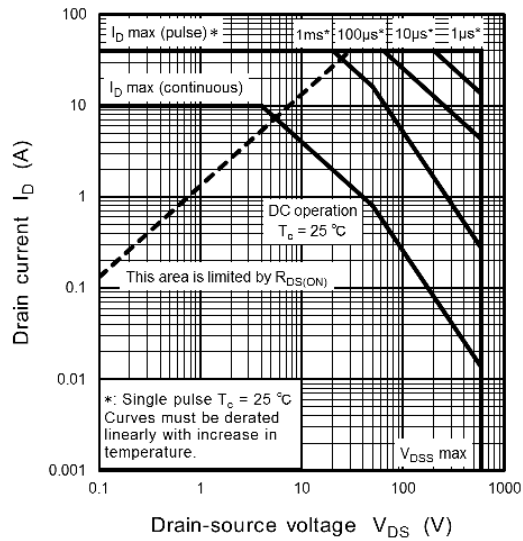
**Fig. 8.15  $P_D - T_c$**   
(Guaranteed Maximum)



$V_{DD} = 90 \text{ V}, L = 3.53 \text{ mH}$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AS}^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

**Fig. 8.16 Test Circuit/Waveform**



**Fig. 8.17 Safe Operating Area  
(Guaranteed Maximum)**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





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